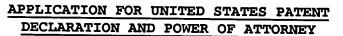


As a below named inventor, I declare that my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor if only one name is listed below, or an original, first and joint inventor if plural inventors are named below, of the subject matter which is claimed and for which a patent is sought on the invention entitled as set forth below, and the title as set forth below which is described in the attached specification; that I have reviewed and understand the contents of the specification, including the claims, as amended by any amendment specifically referred to in the oath or declaration; that no application for patent or inventor's certificate on this invention has been filed by me or my legal representatives or assigns in any country foreign to the United States of America prior to the filing date of said application; and that I acknowledge my duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, section 1.56;

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States code, and that such willful false statements may jeopardize the validity of the application or the part of the part of the statements are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States code, and that such willful false statements may jeopardize the validity of the application or the part of the part o

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TITLE OF INVENTION:			
DUAL HARDMASK PROCESS FOR THE FORMATION OF COPPER/LOW-K INTERCONNECTS			
Practitioners at Customer Number 23494			
SEND CORRESPONDENCE TO: Peter K. McLarty Texas Instruments Incorporated		DIRECT TELEPHONE CALLS TO: Peter K. McLarty	
P.O. Box 655474, MS 3999 Dallas, TX 75265		(972) 917-4258	
NAME OF INVENTOR: (1)	NAME OF INVENTOR: (2)	NAME OF INVENTOR: (3)	
Guoqiang Xing	Kenneth D. Brennan	Ping Jiang	
RESIDENCE & POST OFFICE ADDRESS:	RESIDENCE & POST OFFICE ADDRESS:	RESIDENCE & POST OFFICE ADDRESS:	
4609 Gardenia Way	2610 Dupree Circle	6708 Gray Wolf Drive	
Plano, Texas 75093	Austin, Texas 78748	Plano, Texas 75024	
COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:	
USA	USA	USA	
SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:	
B		Pros	
DATE: 6/26/01	DATE:	DATE: 6/27/01	



As a below named inventor, I declare that my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor if only one name is listed below, or an original, first and joint inventor if plural inventors are named below, of the subject matter which is claimed and for which a patent is sought on the invention entitled as set forth below, and the title as set forth below which is described in the attached specification; that I have reviewed and understand the contents of the specification, including the claims, as amended by any amendment specifically referred to in the oath or declaration; that no application for patent or inventor's certificate on this invention has been filed by me or my legal representatives or assigns in any country foreign to the United States of America prior to the filing date of said application; and that I acknowledge my duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, section 1.56;

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Tritle Of invention:			
DUAL HARDMASK PROCESS FOR THE FORMATION OF COPPER/LOW-K INTERCONNECTS			
POWER OF ATTORNEY: I HEREBY APPOINT THE FOLLOWING ATTORNEYS TO PROSECUTE THIS APPLICATION AND TRANSACT ALL BUSINESS IN THE PATENT AND TRADEMARK OFFICE CONNECTED THEREWITH			
Practitioners at Customer Number 23494			
SEND CORRESPONDENCE TO:		DIRECT TELEPHONE CALLS TO:	
Peter K. McLarty Texas Instruments Incorporated P.O. Box 655474, MS 3999 Dallas, TX 75265		Peter K. McLarty (972) 917-4258	
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COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:	
USA	USA	USA	
SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:	
DATE:	DATE: 6-14-2001	DATE:	